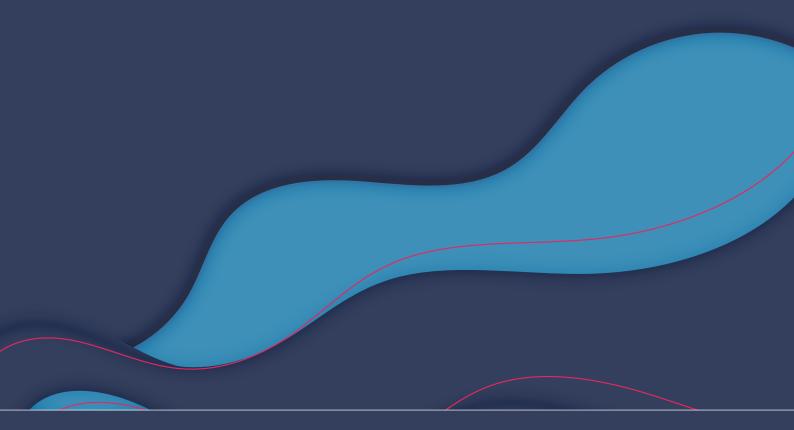


Resilmesh Newsletter

"Resilmesh Open Call 2"







Resilmesh launches Open Call 2 - 72,000€ in funding for innovators enhancing cybersecurity resilience

The Resilmesh project is pleased to announce the launch of **Open Call 2**, inviting applications from SMEs, mid-caps, research organisations, and innovators across Europe to contribute to next-generation cybersecurity resilience. Applications are open now and will be accepted until **November 5, 2025, at 17:00 CET.**

Building on the success of its first call, **Resilmesh Open Call 2** focuses on identifying **real-world use-cases** that will extend the Resilmesh platform into **new critical infrastructure domains**. Up to **five projects** will be selected for funding and integrated into the Resilmesh project, receiving **up to 72,000€** each in **lump-sum contributions** over three intensive development sprints from **January to September 2026.**

With Open Call 2, Resilmesh aims to bridge the gap between cutting-edge cybersecurity research and real-world infrastructure challenges. By supporting innovators who are extending Resilmesh's platform into new domains and creating novel analytics, we are enabling greater adaptability and resilience in the face of sophisticated cyber threats.

Scope and Challenges

Open Call 2 is seeking proposals in two strategic areas:

1. Extension to New Domains and System

- Proposals enhancing the connectivity mesh or interworking mesh of Resilmesh
- Focus on **connectivity, data aggregation, open protocols,** and **interoperability** with third-party tools following **Open XDR Architecture (OXA) principles.**



- 2. New Analytic Algorithms and Architectures
- Zone-based anomaly detection
- Novel edge Al architectures
- User and Entity Behaviour Analytics (UEBA)

Who Can Apply

- Legal entities or consortia (led by a technical partner)
- SMEs, mid-caps, research centres (RTOs), and academia
- Applicants must be based in an EU Member State or Horizon Europe Associated Country
- **UK entities are not eligible** due to funding timeline restrictions

Application Deadline

November 5, 2025, at 17:00 CET

Support and Funding

Selected applicants will:

- Join a 9-month acceleration programme
- Receive up to **72,000€** (disbursed in 3 stages: 25% + 45% + 30%)
- Get access to mentoring, technical support, and integration guidance

How to Apply

- Apply now: https://www.f6s.com/resilmesh-open-call-2/apply
- Contact us: resilmesh@f6s.com
- Submission support: support@f6s.com



Contact Information

Coordinator:

Brian Lee Technological University of Shannon (TUS) Brian.lee@tus.ie



















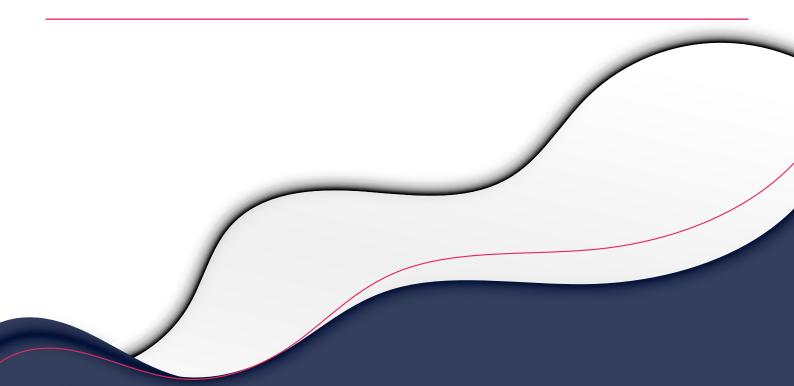














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